



APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-30°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE 3)	
	OPERATING HUMIDITY RANGE	40% TO 80% (NOTE 2)	STORAGE HUMIDITY RANGE	40% TO 70% (NOTE 3)	
	VOLTAGE	250V AC	APPLICABLE CONNECTOR	DF3-*S-2C	
	CURRENT	3A			
SPECIFICATIONS					
ITEM	TEST METHOD		REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.			X	X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE	100mA (DC OR 1000 Hz).		30mΩ MAX.	X	-
INSULATION RESISTANCE	500V DC.		1000MΩ MIN.	X	-
VOLTAGE PROOF	650V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	X	-
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION	30 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			X	-
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55 → 5 TO 35 → +85 → 5 TO 35 °C TIME 30 → 5 MAX → 30 → 5 MAX min UNDER 5 CYCLES.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE, 260 °C FOR IMMERSION, DURATION, 5 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :300°C, SOLDERING TIME :2sec. NO STRENGTH ON CONTACT.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	-
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230°C FOR INSERTION DURATION, 3sec.		SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSERD.	X	-
REMARKS					
NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.					
NOTE2:NO CONDENSING.					
NOTE3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD AFTER PCBBOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
		DIS-H-000745			
Unless otherwise specifid , refer to JIS C 5402.			APPROVED	TY.OMA	06.08.31
			CHECKED	HK.UMEHARA	06.08.31
			DESIGNED	TS.KUMAZAWA	06.08.29
			DRAWN	AK.MIURA	06.08.29
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.	ELC4-162184-04	
	SPECIFICATION SHEET		PART NO.	DF3A-*P-2DSA	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL543	 1/1